

Postforming and Direct Postforming



The method of postforming/direct postforming will determine the adhesive system used.

Dispersion adhesives, based on polyvinyl acetate are sprayed onto both sides, meaning the adhesive is being applied to the profiles chip-board edge, the HPL and CPL and the paper and veneer overlaps.

The same process (i. e. application to both sides) is used for solvent-based adhesives, used mainly in America and Asia.

The demand for following hotmelt is increasing:

- ethylene-vinyl acetate (EVA)
- polyolefin (PO)
- and reactive (PUR) basis.

The hotmelt adhesives are applied one-sided on the overlaps using slot nozzles or application rollers.

The adhesives for direct-postforming must have a superior green strength to compensate for the high memory of laminating materials.

ADHESIVES

A crucial process in the furniture industry is the forming of HPL, CPL and multi layer papers and veneers around profiled edges (postforming/direct postforming). The transition between surface and edge bonding without a visible glue line plays an important role in the production of work tops and also in the production of furniture fronts.



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KLEIBERIT 347

Synthetic resin glue

- for postforming in-line or stationary
- suitable for fast press processing (surface bonding) e. g. bonding of laminates in a short cycle press
- very short setting times

KLEIBERIT 303.8

PVAC dispersion

- bond quality D3 according to DIN/EN 204
- for postforming machines in-line and also stationary
- good spraying properties
- high green strength

KLEIBERIT 777 EVA-HM

- for direct-postforming, softforming and for straight edges
- high heat resistance up to 100°C

KLEIBERIT 753.5 PO-HM

Polyolefin hotmelt adhesive for edgebanding, also in the CNC processing centre, for laminating materials such as HPL, CPL, strong paper and veneer.

- very good melting behaviour
- high temperature resistance from -20°C up to 120°C
- very high green strength

KLEIBERIT 707.7/707.9 PUR-HM

Polyurethane hotmelt for postforming of HPL, CPL, multi layer papers and veneers.

- with additional chemical cross linking
- excellent temperate, moisture, water and steam resistance
- application equipment: roller, nozzle

KLEIBERIT 152.5 SP

Polychloroprene solvent-based adhesive

- for HPL/CPL surface bonding and postforming in-line
- for stationary postforming processes

Direct-postforming is possible for a multitude of laminating materials such as veneer, paper, CPL and HPL.

Adhesives for postforming and direct-postforming (field of application e. g. worktops, kitchen fronts)

Product	Basis	Application	Properties	Machines
152 SP	Polychloroprene	spray application both sides	<ul style="list-style-type: none"> • excellent green strength for HPL bondings up to 1 mm 	Suitable for in-line as well as stationary process
347	PVAC-dispersion	application on both sides a) spray method b) overhang with application roller / profile with spray application	<ul style="list-style-type: none"> • very good sprayable • no clog up of application jets • high green strength • HPL up to 1 mm possible • D2-adhesive (DIN/EN 204/205) 	Postforming, in-line with speeds between 2 - 25 m/min. • IMA, Lübecke/Germany • Homag, Schopfloch/Germany • Evans, USA • Midland, USA • IDM, Italy Stationary postforming machines: • Brandt, Lemgo/Germany • Evans, USA • Midland, USA
303.8	PVAC-dispersion		<ul style="list-style-type: none"> • D3-adhesive DIN EN 204/205 • very good sprayable • high green strength • HPL up to 0,8 mm possible 	
777	EVA-hotmelt	<ul style="list-style-type: none"> • application single side with heatable application roller or heatable slot-nozzle 	<ul style="list-style-type: none"> • temperature resistance • -20° C to 80° C • CPL/HPL-materials up to 0,6 mm 	Direct postforming, in-line with speeds between 10 - 20 m/min. • IMA AG, Lübecke • Homag, Schopfloch/Germany • IDM, Italy • SCM, Italy
753.5	PO-hotmelt		<ul style="list-style-type: none"> • temperature resistance • -20° C to 110° C • depending on material thickness • very high green strength • CPL/HPL-materials up to 0,8 mm possible 	
707.9	Reactive PUR-hotmelt		<ul style="list-style-type: none"> • temperature resistance • -20° C to 140° C • depending on material thickness • CPL/HPL-materials up to 0,6 mm • high green strength • with long pressure-area up to 0,8 mm 	